TAP2000 Series

Ultra High Power Planar Resistor

The Ohmite TAP2000 series offers 2000 watts of power dissipation when properly heatsinked. The design of the TAP series creates a constant pressure to the cooling plate of approximately 300 N for proper thermal flow. The TAP2000 is ideal for variable speed drives, power supplies, control devices, robotics, motor control and other power designs.

Weight ~120 g

FEATURES

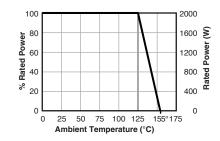
- 2,000 W operating power with proper heatsinking
- Non-Inductive design
- ROHS compliant
- High insulation & partial discharge performance
- Materials in accordance with UL 94 V-0



Resistance value $0.15\Omega \le 0.99\Omega$ (HC-version); $> 0.99\Omega \le 6$ K Ω (higher values on request) Resistance tolerance ±5 % to ±10 % Temp. coefficient ±150 ppm/°C Standard; lower TCR on special request for limited ohmic values 2,000 W at 125°C bottom case temperature resp. Power rating 60°C heat sink temperature 2,400 W at 70°C for 10sec., ΔR = 0.4% max. Short time overload 5,000 V DC = 3.500 V AC RMS (50 Hz); higher volt-Max. working voltage age on request, not exceeding max. power Max. cont. current 120 A Electric strenath 7 kVrms / 50 Hz / 500 VA. test time 1 min. between terminal und case (up to 12 kVrms on request). voltage Voltages above 10 kVrms are tested at DC equivalent to avoid pre damage of component 4 kVrms < 10 pC (up to 7 kVrms < 10 pC on request) Partial discharge acc. to IEC 60270 Pulse peak current up to 1,500 A depending on pulse length and frequency (ask for details) Insulation resistance > 10 G Ω at 1,000 V Single shot voltage up to 12 kV norm wave (1.5/50 µsec) Creeping distance > 42mm (standard, higher on request) > 14mm (standard, higher on request) Air distance Inductance ≥ 80 nH (typical), measuring frequency 10 kHz Capacity/mass ≥ 120 pF (typical), measuring frequency 10 kHz Capacity/parallel ≥ 40 pF (typical), measuring frequency 10 kHz Oper. temperature -55°C to +155°C Mounting torque for contacts 1.8 Nm to 2 Nm; torque 1.6 Nm to 1.8 Nm M4 screws

Base Plate Alumina ceramic metalized film on the base plate for improved heat transfer Resin-filled epoxy casing with large Encapsulation creeping distance to mass, large air distance between the terminals and high insulation resistance (CTI 600) Resistance Special design for low inductance and capacitance values. The element dem-Element onstrates stability while covering high wattage and pulse loading Contacts · Various sleeves for increasing creeping distance up to 85mm · Contacts standard M5 (M4 on special request - connection screw thread max. 7mm

Derating



Derating (thermal resist.) 66.6 W/K (0.015 K/W) Power rating: 2,000 W at 125°C bottom case temperature

Please ask for detailed mounting procedure!

Best results can be reached by using a thermal transfer compound with a heat conductivity of at least 2.9 W/mK. The flatness of the cooling plate must be better than 0.05 mm overall. Surface roughness should not exceed 6.4 µm.

CHARACTERISTICS

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PERFORMANCE DATA

Test	Method	$\Delta \mathbf{R}$
Short time overload	2,400 W/10sec.	0.40%
Humidity steady	56 days/40°C/95%	0.25%
state		
Temp. Cycling	-55/+125/5cycles	0.20%
Shock	40g/4,000 times	0.25%
Vibrations	2-500Hz/10g	0.25%
Load life	3,000cyl PN 30 min. on / 30 min off	0.40%
Terminal strength	200 N for hexa. thread con- tacts	0.05%
test methods are according to IEC 60068-2		

(4.175mm ±.13) 2.36" ±.031 *C to C for (60mm ±.8) Connection screw mounting holes thread max 7mm 2.244" ±.008 (57mm ±.2) 0.71" ±.02 2.244" ±.02 $(18mm \pm .5)$ (57mm ±.5) 1.338" ±.008 (34mm ±.2) 0.2" ±.02 (5mm ±.5) 0 2.56" ±.031 (65mm ±.8) ← 1.417" ±.008 -> (36mm ±.2) 0.276" ±.02 0.197" ±.02 (7mm ±.5) (5mm ±.5) 1.26" ±.02 1.181" ±.02 (32mm ±.5) (30mm ±.5) Air distance: 14mm [0.5512] min. Creeping distance: 42mm [1.6535] min. 0.59" ±.02 (15mm ±.5)

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DIMENSIONS

øM5 (DIN) std. (M4 on request)

ø0.16" ±.005

ORDERING INFORMATION

RoHS compliant T A P 2 0 0 0 H C K 5 R 0 E l Series 1 High-current Tolerance Resistance K = 10% for values below 1Q

THIS PRODUCT IS DESIGNED FOR **USE WITH PROPER HEATSINKING.**

Maximum base plate temperature of the resistor must be monitored and kept within specified limits to establish the power rating. Best technique is to attach a thermocouple to the side of the base plate of the resistor. Temperature of plastic housing or heat sink cannot be used to establish rating of the resistor. The Ohmite CP4 (https://www.ohmite.com/cp4-series-chillplate/) is an example of properly designed heat sink.

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